

Work

Hardware Prototyping Engineer - IC5

Nov 2021 — Jul 2023

Meta Reality Labs, Seattle WA.

- Spearheaded hundreds of prototyping projects with varied and unique demands in collaboration with a wide range of engineering teams within Meta Reality Labs (RL) and RL Research
- SME on prototyping projects requiring 3D printing + ancillary fabrication methods incl. molding, CNC, electrodeposition
- Collaborative R&D:
 - Engineered and validated new hybrid tooling, enabled selective finishing of near-net 3DP parts via 5-axis CNC - reducing machine and programming time by up to 60% vs multi-setup strategies.
 - Developed novel process for tool-less prototyping of thin (10-300µm) conductive flexes and antennas. Reduced lead time from 2 weeks to 2-3 days.
- Established AM partnerships - Deployed cutting edge, direct-print thiol-ene silicone 3DP materials 1-2 years ahead of global availability
- Improved processes - Created tools to help HW Eng & Prod Design teams to make more informed decisions when interacting with the service-bureau team, and improve reliability of 3D print farm output

Vertical Product Manager

Jan 2019 — Nov 2021

Formlabs, Somerville MA.

- Responsible for Formlabs' investment cast mfg. vertical and Formlabs' composite material projects. Brought three specialized 3D printing resins to market.
- Work closely with materials science team and provide applications-based product feedback throughout R&D.
- Cultivated strategic partnerships with equipment manufacturers to outsource product validation

Applications Research Engineer

June 2016 — Present

Formlabs, Somerville MA.

- Hands-on development and optimization of burnout, debinding and sintering processes for composite resins, and protocols for analysis of IC refractory molds, via test design, fluid simulation, and metrology
- Development and optimization of processing techniques for composite ceramic SLA materials.
- Contributed to mechanical design of Fuse SLS printer. Designed master-sketch driven sheet metal components and replaceable heater/filter assemblies based on COMSOL studies.

3D Designer

June 2011 — September 2011

Lippincott, New York.

- 3D Concept design and visualization of new branding, retail interiors for Samsung, Nissan, Comcast, United Airlines, and Mastercard.

Education

New Jersey Institute of Technology

Graduated May 2016

Bachelor of Arts in Design and Digital Arts

University of Cincinnati, College of Design, Art, Architecture and Planning

3 years

Bachelor of Science in Architecture

Software

Solidworks, Onshape, Fusion360 (CAM) N-Topology Platform, COMSOL (Composite Mechanics, Electrochemistry, Optimization Modules), Blender, Maya, Adobe CC, Keyence VK Analyzer, GOM Inspect

Skills

CAD/CAM, Materials test design, Part design for AM, Lost-resin metal investment casting, Ceramics debinding and sintering, Metrology, Multiphysics simulation, Topology optimization, Technical writing